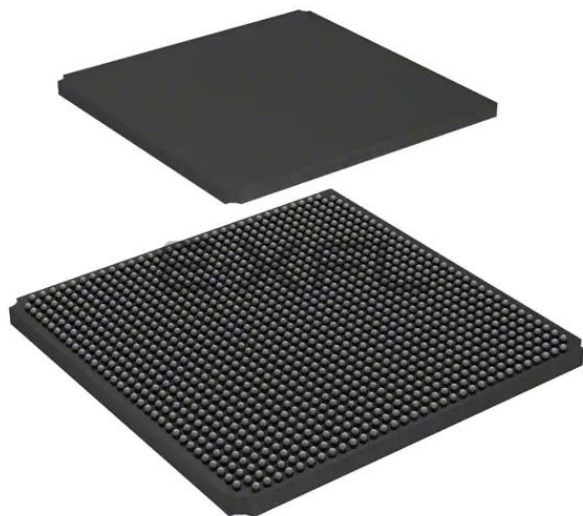




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	11875
Number of Logic Elements/Cells	95000
Total RAM Bits	5435392
Number of I/O	520
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FPBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m100se-5f1152i

for checking soft errors (SED) in SRAM. SED can be run on a programmed device when the user logic is not active. If a soft error occurs, during user mode (normal operation) the device can be programmed to either reload from a known good boot image or generate an error signal.

For further information about Soft Error Detect (SED) support, please see the list of additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP2/M devices require a single external, 10K ohm $\pm 1\%$ value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

On-Chip Oscillator

Every LatticeECP2/M device has an internal CMOS oscillator which is used to derive a Master Clock for configuration. The oscillator and the Master Clock run continuously and are available to user logic after configuration is completed. The software default value of the Master Clock is 2.5MHz. Table 2-16 lists all the available Master Configuration Clock frequencies for normal non-encrypted mode and encrypted mode. When a different Master Clock is selected during the design process, the following sequence takes place:

1. Device powers up with a Master Clock frequency of 3.1MHz.
2. During configuration, users select a different master clock frequency.
3. The Master Clock frequency changes to the selected frequency once the clock configuration bits are received.
4. If the user does not select a master clock frequency, then the configuration bitstream defaults to the Master Clock frequency of 2.5MHz.

This internal CMOS oscillator is available to the user by routing it as an input clock to the clock tree. For further information about the use of this oscillator for configuration or user mode, please see the list of additional technical documentation at the end of this data sheet.

Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration

Non-Encrypted Mode CCLK (MHz)			Encrypted Mode CCLK (MHz)
2.5 ¹	13.0	45.0	2.5 ¹
4.3	15.0	55.0	5.4
5.4	20.0	60.0	10.0
6.9	26.0	—	—
8.1	30.0	—	—
9.2	34.0	—	—
10.0	41.0	130.0	—

1. Software default frequency.

Density Shifting

The LatticeECP2/M family is designed to ensure that different density devices in the same family and in the same package have the same pinout. Furthermore, the architecture ensures a high success rate when performing design migration from lower density devices to higher density devices. In many cases, it is also possible to shift a lower utilization design targeted for a high-density device to a lower density device. However, the exact details of the final resource utilization will impact the likelihood of success in each case. Design migration between LatticeECP2 and LatticeECP2M families is not possible. For specific requirements relating to sysCONFIG pins of the ECP2M50, M70 and M100, see the Logic Signal Connections tables.

LatticeECP2 Supply Current (Standby)^{1, 2, 3, 4}
Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	ECP2-6	10	mA
		ECP2-12	20	mA
		ECP2-20	30	mA
		ECP2-35	50	mA
		ECP2-50	70	mA
		ECP2-70	100	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2-6	24	mA
		ECP2-12	24	mA
		ECP2-20	24	mA
		ECP2-35	24	mA
		ECP2-50	24	mA
		ECP2-70	24	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCSPLL}	GPLL Power Supply Current (per SPLL)	ECP2-35, -50, -70 Only	0.5	mA
I_{CCIO}	Bank Power Supply Current (Per Bank)	ECP2-6	2	mA
		ECP2-12	2	mA
		ECP2-20	2	mA
		ECP2-35	2	mA
		ECP2-50	2	mA
		ECP2-70	2	mA
I_{CCJ}	VCCJ Power Supply Current	All Devices	3	mA

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
2. Assumes all outputs are tristated, all inputs are configured as LVCMOS and held at the V_{CCIO} or GND.
3. Frequency 0MHz.
4. Pattern represents a "blank" configuration data file.
5. $T_J = 25^{\circ}\text{C}$, power supplies at normal voltage.

BLVDS

The LatticeECP2/M devices support the BLVDS standard. This standard is emulated using complementary LVC-MOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

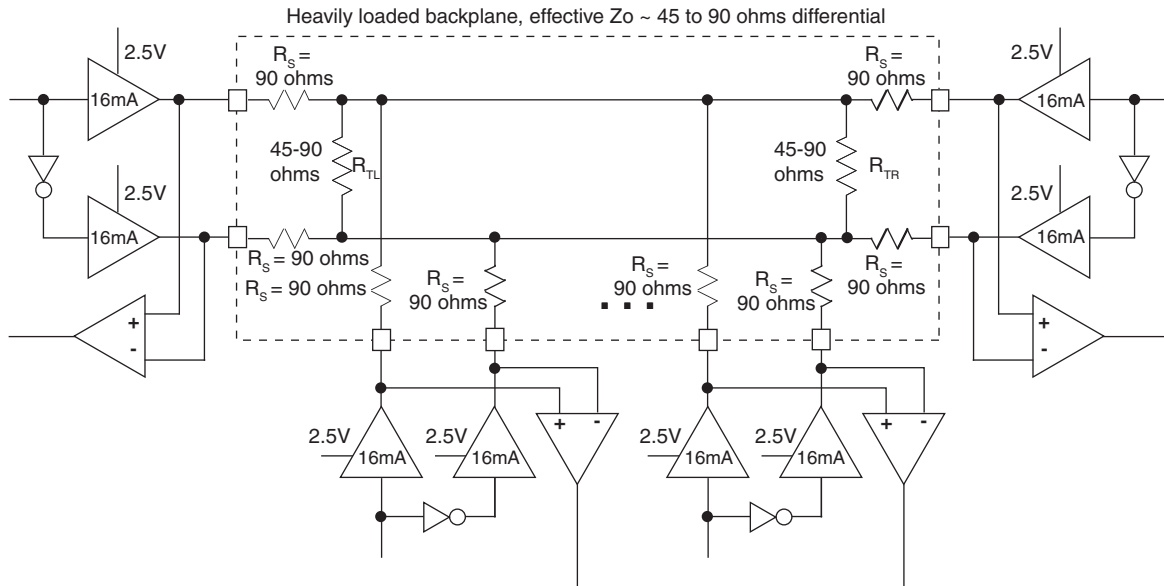


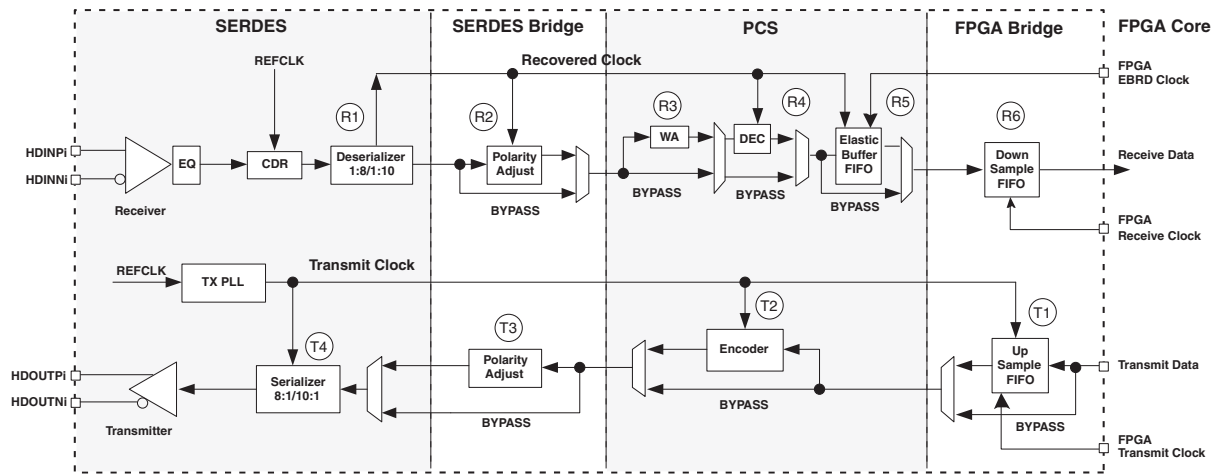
Table 3-3. BLVDS DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45Ω	Zo = 90Ω	
VCCIO	Output Driver Supply (+/- 5%)	2.50	2.50	V
ZOUT	Driver Impedance	10.00	10.00	Ω
RS	Driver Series Resistor (+/- 1%)	90.00	90.00	Ω
RTL	Driver Parallel Resistor (+/- 1%)	45.00	90.00	Ω
RTR	Receiver Termination (+/- 1%)	45.00	90.00	Ω
VOH	Output High Voltage	1.38	1.48	V
VOL	Output Low Voltage	1.12	1.02	V
VOD	Output Differential Voltage	0.25	0.46	V
VCM	Output Common Mode Voltage	1.25	1.25	V
IDC	DC Output Current	11.24	10.20	mA

1. For input buffer, see LVDS table.

Figure 3-12. Transmitter and Receiver Block Diagram



SERDES High Speed Data Receiver (LatticeECP2M Family Only)

Table 3-11. Serial Input Data Specifications

Symbol	Description	Min.	Typ.	Max.	Units
RX-CID _S	Stream of nontransitions ¹ (CID = Consecutive Identical Digits) @ 10 ⁻¹² BER		7 @ 3.125 Gbps 20 @ 1.25 Gbps		Bits
V _{RX-DIFF-S}	Differential input sensitivity	100	—	—	mV, p-p
V _{RX-IN}	Input levels	0	—	V _{CCR_X} + 0.8	V
V _{RX-CM-DC}	Input common mode range (DC coupled)	0.5	—	1.2	V
V _{RX-CM-AC}	Input common mode range (AC coupled) ³	0	—	1.5	V
T _{RX-RELOCK}	CDR re-lock time ²	—	—	3000	Bits
Z _{RX-TERM}	Input termination 50/75 Ohm/High Z	—	50		Ohms
RL _{RX-RL}	Return loss (without package)	—	9	—	dB

1. This is the number of bits allowed without a transition on the incoming data stream when using DC coupling.
2. This is the typical number of bit times to re-lock to a new phase of frequency within +/- 300 ppm, assuming 8b10b encoded data and the CDR is in lock state. When CDR is in un-lock state, or reset is applied, the total re-lock settling time will be approximately 4ms including analog settle time, calibration time, and acquisition time.
3. AC coupling is used to interface to LVPECL and LVDS.

Input Data Jitter Tolerance

A receiver's ability to tolerate incoming signal jitter is very dependent on jitter type. High speed serial interface standards have recognized the dependency on jitter type and have recently modified specifications to indicate tolerance levels for different jitter types as they relate to specific protocols (e.g. FC, etc.). Sinusoidal jitter is considered to be a worst case jitter type.

Table 3-12. Receiver Total Jitter Tolerance Specification¹

Description	Frequency	Condition	Min.	Typ.	Max.	Units
Deterministic	3.125 Gbps	600 mV differential eye	—	—	0.54	UI, p-p
Random		600 mV differential eye	—	—	0.26	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	2.5 Gbps	600 mV differential eye	—	—	0.61	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.81	UI, p-p
Deterministic	1.25 Gbps	600 mV differential eye	—	—	0.53	UI, p-p
Random		600 mV differential eye	—	—	0.22	UI, p-p
Total		600 mV differential eye	—	—	0.80	UI, p-p
Deterministic	250 Mbps ²	600 mV differential eye	—	—	0.42	UI, p-p
Random		600 mV differential eye	—	—	0.10	UI, p-p
Total		600 mV differential eye	—	—	0.60	UI, p-p

1. Values are measured with PRBS 2⁷-1, all channels operating, FPGA Logic active, I/Os around SERDES pins quiet, voltages are nominal, room temperature.
2. Jitter specification is limited by measurement equipment capability.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE			
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential
46	NC	5			PB16B	5	BDQ15	C
47	GND	-			GND	-		
48	VCC				VCC	-		
49	PB8A	5	PCLKT5_0/BDQ6	T	PB26A	5	PCLKT5_0/BDQ24	T
50	PB8B	5	PCLKC5_0/BDQ6	C	PB26B	5	PCLKC5_0/BDQ24	C
51	GND	-			GND	-		
52	PB13A	4	PCLKT4_0/BDQ15	T	PB31A	4	PCLKT4_0/BDQ33	T
53	PB13B	4	PCLKC4_0/BDQ15	C	PB31B	4	PCLKC4_0/BDQ33	C
54	VCC	-			VCC	-		
55	PB14A	4	BDQ15	T	PB34A	4	BDQ33	T
56	PB14B	4	BDQ15	C	PB34B	4	BDQ33	C
57	PB16A	4	BDQ15	T	PB40A	4	BDQ42	T
58	PB16B	4	BDQ15	C	PB40B	4	BDQ42	C
59	PB18A	4	BDQ15	T	PB44A	4	BDQ42	T
60	PB18B	4	BDQ15	C	PB44B	4	BDQ42	C
61	GND	-			GND	-		
62	PB20A	4	BDQ24	T	PB48A	4	BDQ51	T
63	PB20B	4	BDQ24	C	PB48B	4	BDQ51	C
64	VCCIO4	4			VCCIO4	4		
65	PB22A	4	BDQ24	T	PB50A	4	BDQ51	T
66	PB22B	4	BDQ24	C	PB50B	4	BDQ51	C
67	PB24A	4	BDQS24	T	PB52A	4	BDQ51	T
68	PB24B	4	BDQ24	C	PB52B	4	BDQ51	C
69	PB26A	4	BDQ24	T	PB54A	4	BDQ51	T
70	PB26B	4	BDQ24	C	PB54B	4	BDQ51	C
71	PB28A	4	VREF2_4/BDQ24	T	PB55A	4	VREF2_4/BDQ51	T
72	PB28B	4	VREF1_4/BDQ24	C	PB55B	4	VREF1_4/BDQ51	C
73	CFG1	8			CFG1	8		
74	CFG2	8			CFG2	8		
75	PROGRAMN	8			PROGRAMN	8		
76	INITN	8			INITN	8		
77	CFG0	8			CFG0	8		
78	CCLK	8			CCLK	8		
79	DONE	8			DONE	8		
80	PR29A	8	D0/SPIFASTN		PR29A	8	D0/SPIFASTN	
81	GND	-			GND	-		
82	PR26A	8	D6		PR26A	8	D6	
83	VCC	-			VCC	-		
84	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
85	VCCIO8	8			VCCIO8	8		
86	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
87	PR24B	8	DOUT/CSON	C	PR24B	8	DOUT/CSON	C
88	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
89	VCCIO3	3			VCCIO3	3		
90	VCCAUX	-			VCCAUX	-		

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P5	P5	VCCIO5	5		
K5	K5	VCCIO6	6		
M3	M3	VCCIO6	6		
E3	E3	VCCIO7	7		
G5	G5	VCCIO7	7		
T15	T15	VCCIO8	8		
A1	A1	GND	-		
A16	A16	GND	-		
B12	B12	GND	-		
B5	B5	GND	-		
C8	C8	GND	-		
E15	E15	GND	-		
E2	E2	GND	-		
H14	H14	GND	-		
H8	H8	GND	-		
H9	H9	GND	-		
J3	J3	GND	-		
J8	J8	GND	-		
J9	J9	GND	-		
M15	M15	GND	-		
M2	M2	GND	-		
P9	P9	GND	-		
R12	R12	GND	-		
R5	R5	GND	-		
T1	T1	GND	-		
T16	T16	GND	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
J22	PR29B	3	RDQ31	C (LVDS)*	PR48B	3	RDQ50	C (LVDS)*
H22	PR29A	3	RDQ31	T (LVDS)*	PR48A	3	RDQ50	T (LVDS)*
VCCIO	VCCIO3	3			VCCIO	3		
M20	PR28B	3	VREF2_3/RDQ31	C	PR47B	3	VREF2_3/RDQ50	C
L21	PR28A	3	VREF1_3/RDQ31	T	PR47A	3	VREF1_3/RDQ50	T
K21	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	PR46B	3	PCLKC3_0/RDQ50	C (LVDS)*
J21	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	PR46A	3	PCLKT3_0/RDQ50	T (LVDS)*
M18	PR25B	2	PCLKC2_0/RDQ22	C	PR44B	2	PCLKC2_0/RDQ41	C
L17	PR25A	2	PCLKT2_0/RDQ22	T	PR44A	2	PCLKT2_0/RDQ41	T
GNDIO	GNDIO2	-			GNDIO2	-		
L19	PR24B	2	RDQ22	C (LVDS)*	PR43B	2	RDQ41	C (LVDS)*
L20	PR24A	2	RDQ22	T (LVDS)*	PR43A	2	RDQ41	T (LVDS)*
L18	PR23B	2	RDQ22	C	PR42B	2	RDQ41	C
K17	PR23A	2	RDQ22	T	PR42A	2	RDQ41	T
VCCIO	VCCIO2	2			VCCIO	2		
K18	PR22B	2	RDQ22	C (LVDS)*	PR41B	2	RDQ41	C (LVDS)*
K19	PR22A	2	RDQS22	T (LVDS)*	PR41A	2	RDQS41	T (LVDS)*
G22	PR21B	2	RDQ22	C	PR40B	2	RDQ41	C
GNDIO	GNDIO2	-			GNDIO2	-		
F22	PR21A	2	RDQ22	T	PR40A	2	RDQ41	T
J17	PR20B	2	RDQ22	C (LVDS)*	PR39B	2	RDQ41	C (LVDS)*
J18	PR20A	2	RDQ22	T (LVDS)*	PR39A	2	RDQ41	T (LVDS)*
K20	PR19B	2	RDQ22	C	PR38B	2	RDQ41	C
VCCIO	VCCIO2	2			VCCIO	2		
J19	PR19A	2	RDQ22	T	PR38A	2	RDQ41	T
H21	PR18B	2	RDQ22	C (LVDS)*	PR37B	2	RDQ41	C (LVDS)*
G21	PR18A	2	RDQ22	T (LVDS)*	PR37A	2	RDQ41	T (LVDS)*
-	-	-			GNDIO2	-		
-	-	-			VCCIO	2		
H17	NC	-			PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C
H16	NC	-			PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T
H20	NC	-			PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C
H18	NC	-			PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T
-	-	-			GNDIO2	-		
-	-	-			VCCIO	2		
F21	PR17B	2	RDQ14	C	PR19B	2	RDQ16	C
GNDIO	GNDIO2	-			GNDIO2	-		
E22	PR17A	2	RDQ14	T	PR19A	2	RDQ16	T
D22	PR16B	2	RDQ14	C (LVDS)*	PR18B	2	RDQ16	C (LVDS)*
E21	PR16A	2	RDQ14	T (LVDS)*	PR18A	2	RDQ16	T (LVDS)*
G20	PR15B	2	RDQ14	C	PR17B	2	RDQ16	C
VCCIO	VCCIO2	2			VCCIO	2		
F20	PR15A	2	RDQ14	T	PR17A	2	RDQ16	T
H19	PR14B	2	RDQ14	C (LVDS)*	PR16B	2	RDQ16	C (LVDS)*
G19	PR14A	2	RDQS14	T (LVDS)*	PR16A	2	RDQS16	T (LVDS)*
GNDIO	GNDIO2	-			GNDIO2	-		

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO1	-			GNDIO1	-		
C15	PT45B	1		C	PT45B	1		C
A15	PT45A	1		T	PT45A	1		T
A13	PT44B	1		C	PT44B	1		C
B13	PT44A	1		T	PT44A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
H17	PT43B	1		C	PT43B	1		C
H15	PT43A	1		T	PT43A	1		T
D13	PT42B	1		C	PT42B	1		C
C14	PT42A	1		T	PT42A	1		T
GND	GNDIO1	-			GNDIO1	-		
G14	PT41B	1		C	PT41B	1		C
E14	PT41A	1		T	PT41A	1		T
A12	PT40B	1		C	PT40B	1		C
B12	PT40A	1		T	PT40A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
F14	PT39B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C
D14	PT39A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T
H16	XRES	1			XRES	1		
H14	PT37B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C
GND	GNDIO0	-			GNDIO0	-		
H13	PT37A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T
A11	PT36B	0		C	PT36B	0		C
B11	PT36A	0		T	PT36A	0		T
C13	PT35B	0		C	PT35B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
E13	PT35A	0		T	PT35A	0		T
D12	PT34B	0		C	PT34B	0		C
F13	PT34A	0		T	PT34A	0		T
A10	PT33B	0		C	PT33B	0		C
B10	PT33A	0		T	PT33A	0		T
C12	PT32B	0		C	PT32B	0		C
GND	GNDIO0	-			GNDIO0	-		
C10	PT32A	0		T	PT32A	0		T
G13	PT31B	0		C	PT31B	0		C
VCCIO	VCCIO0	0			VCCIO0	0		
H12	PT31A	0		T	PT31A	0		T
A9	PT30B	0		C	PT30B	0		C
B9	PT30A	0		T	PT30A	0		T
E12	PT29B	0		C	PT29B	0		C
G12	PT29A	0		T	PT29A	0		T
A8	PT28B	0		C	PT28B	0		C
B8	PT28A	0		T	PT28A	0		T
GND	GNDIO0	-			GNDIO0	-		
E11	PT27B	0		C	PT27B	0		C
C9	PT27A	0		T	PT27A	0		T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
A2	GND	-			GND	-		
A25	GND	-			GND	-		
AA18	GND	-			GND	-		
AA24	GND	-			GND	-		
AA3	GND	-			GND	-		
AA9	GND	-			GND	-		
AD11	GND	-			GND	-		
AD16	GND	-			GND	-		
AD21	GND	-			GND	-		
AD6	GND	-			GND	-		
AE1	GND	-			GND	-		
AE26	GND	-			GND	-		
AF2	GND	-			GND	-		
AF25	GND	-			GND	-		
B1	GND	-			GND	-		
B26	GND	-			GND	-		
C11	GND	-			GND	-		
C16	GND	-			GND	-		
C21	GND	-			GND	-		
C6	GND	-			GND	-		
F18	GND	-			GND	-		
F24	GND	-			GND	-		
F3	GND	-			GND	-		
F9	GND	-			GND	-		
J13	GND	-			GND	-		
J14	GND	-			GND	-		
J21	GND	-			GND	-		
J6	GND	-			GND	-		
K10	GND	-			GND	-		
K11	GND	-			GND	-		
K13	GND	-			GND	-		
K14	GND	-			GND	-		
K16	GND	-			GND	-		
K17	GND	-			GND	-		
L10	GND	-			GND	-		
L11	GND	-			GND	-		
L16	GND	-			GND	-		
L17	GND	-			GND	-		
L24	GND	-			GND	-		
L3	GND	-			GND	-		
M13	GND	-			GND	-		
M14	GND	-			GND	-		
N10	GND	-			GND	-		
N12	GND	-			GND	-		
N13	GND	-			GND	-		
N14	GND	-			GND	-		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AH24	PB89A	4	BDQ87	T
AH25	PB89B	4	BDQ87	C
VCCIO	VCCIO4	4		
AJ26	PB90A	4	BDQ87	T
AK26	PB90B	4	BDQ87	C
AF25	PB91A	4	BDQ87	T
AG25	PB91B	4	BDQ87	C
GND	GNDIO4	-		
AK22	PB92A	4	BDQ96	T
AJ22	PB92B	4	BDQ96	C
AE22	PB93A	4	BDQ96	T
AF22	PB93B	4	BDQ96	C
AG22	PB94A	4	BDQ96	T
VCCIO	VCCIO4	4		
AH22	PB94B	4	BDQ96	C
AG24	PB95A	4	BDQ96	T
AG23	PB95B	4	BDQ96	C
AE23	PB96A	4	BDQS96	
GND	GNDIO4	-		
AC22	PB97A	4	BDQ96	
AJ23	PB98A	4	BDQ96	T
VCCIO	VCCIO4	4		
AK23	PB98B	4	BDQ96	C
AD24	PB99A	4	BDQ96	T
AF24	PB99B	4	BDQ96	C
AC23	PB100A	4	VREF2_4/BDQ96	T
GND	GNDIO4	-		
AE24	PB100B	4	VREF1_4/BDQ96	C
AE25	CFG2	8		
AB22	CFG1	8		
AE26	CFG0	8		
AA22	PROGRAMN	8		
AD25	CCLK	8		
AD26	INITN	8		
AC24	DONE	8		
GND	GNDIO4	-		
AC25	PR90B	8	WRITEN	C
AE27	PR90A	8	CS1N	T
AC26	PR89B	8	CSN	C
AE28	PR89A	8	D0/SPIFASTN	T
VCCIO	VCCIO8	8		
AD27	PR88B	8	D1	C
AD28	PR88A	8	D2	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
E27	NC	-		
E28	NC	-		
E29	NC	-		
E3	NC	-		
E30	NC	-		
E4	NC	-		
E5	NC	-		
E6	NC	-		
F25	NC	-		
F5	NC	-		
F6	NC	-		
G6	NC	-		
G7	NC	-		
K10	NC	-		
K9	NC	-		
N27	NC	-		
N4	NC	-		
R1	NC	-		
R2	NC	-		
V27	NC	-		
V4	NC	-		
P22	VCCPLL	-		
P8	VCCPLL	-		
T22	VCCPLL	-		
Y7	VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D23	NC	-			NC	-			
D24	NC	-			NC	-			
D25	NC	-			NC	-			
D26	NC	-			NC	-			
E20	NC	-			NC	-			
E21	NC	-			NC	-			
E25	NC	-			NC	-			
E26	NC	-			NC	-			
F20	NC	-			NC	-			
G20	NC	-			NC	-			
K10	NC	-			NC	-			
K17	NC	-			NC	-			
R4	NC	-			NC	-			
U10	NC	-			NC	-			
U23	NC	-			NC	-			
V10	NC	-			NC	-			
W7	NC	-			NC	-			
AB21	PB69B	4	BDQ69	C	NC	-			
AC20	PB58A	4	BDQ60	T	NC	-			
AC21	PB63A	4	BDQ60	T	NC	-			
AC22	PB69A	4	BDQS69****	T	NC	-			
AC23	PB71A	4	BDQ69	T	NC	-			
AC25	PB71B	4	BDQ69	C	NC	-			
AD26	PB70B	4	BDQ69	C	NC	-			
W20	PB72B	4	BDQ69	C	NC	-			
H7	L_VCCPLL	-			L_VCCPLL	-			
K6	L_VCCPLL	-			L_VCCPLL	-			
P7	L_VCCPLL	-			L_VCCPLL	-			
R8	L_VCCPLL	-			L_VCCPLL	-			
V18	R_VCCPLL	-			R_VCCPLL	-			
P20	R_VCCPLL	-			R_VCCPLL	-			
J17	R_VCCPLL	-			R_VCCPLL	-			
G19	R_VCCPLL	-			R_VCCPLL	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
T2	PL45B	6	LLM3_SPLLC_IN_A	C (LVDS)*	PL57B	6	LLM3_SPLLC_IN_A/LDQ55	C (LVDS)*	
U9	PL46A	6	LLM3_SPLLT_FB_A	T	PL58A	6	LLM3_SPLLT_FB_A/LDQ55	T	
U8	PL46B	6	LLM3_SPLLC_FB_A	C	PL58B	6	LLM3_SPLLC_FB_A/LDQ55	C	
VCCIO	VCCIO6	6			GNDIO6	-			
U5	PL48A	6	LDQ52	T (LVDS)*	PL60A	6	LDQ64	T (LVDS)*	
U4	PL48B	6	LDQ52	C (LVDS)*	PL60B	6	LDQ64	C (LVDS)*	
V9	PL49A	6	LDQ52	T	PL61A	6	LDQ64	T	
V7	PL49B	6	LDQ52	C	PL61B	6	LDQ64	C	
VCCIO	VCCIO6	6			VCCIO6	6			
U3	PL50A	6	LDQ52	T (LVDS)*	PL62A	6	LDQ64	T (LVDS)*	
U2	PL50B	6	LDQ52	C (LVDS)*	PL62B	6	LDQ64	C (LVDS)*	
V8	PL51A	6	LDQ52	T	PL63A	6	LDQ64	T	
U6	PL51B	6	LDQ52	C	PL63B	6	LDQ64	C	
GNDIO	GNDIO6	-			GNDIO6	-			
U1	PL52A	6	LDQS52	T (LVDS)*	PL64A	6	LDQS64	T (LVDS)*	
V2	PL52B	6	LDQ52	C (LVDS)*	PL64B	6	LDQ64	C (LVDS)*	
V5	PL53A	6	LDQ52	T	PL65A	6	LDQ64	T	
VCCIO	VCCIO6	6			VCCIO6	6			
V6	PL53B	6	LDQ52	C	PL65B	6	LDQ64	C	
V1	PL54A	6	LDQ52	T (LVDS)*	PL66A	6	LDQ64	T (LVDS)*	
W1	PL54B	6	LDQ52	C (LVDS)*	PL66B	6	LDQ64	C (LVDS)*	
W5	PL55A	6	LDQ52	T	PL67A	6	LDQ64	T	
GNDIO	GNDIO6	-			GNDIO6	-			
W6	PL55B	6	LDQ52	C	PL67B	6	LDQ64	C	
W3	PL57A	6		T (LVDS)*	PL69A	6	LDQ73	T (LVDS)*	
W4	PL57B	6		C (LVDS)*	PL69B	6	LDQ73	C (LVDS)*	
W2	PL58A	6		T	PL70A	6	LDQ73	T	
Y4	PL58B	6		C	PL70B	6	LDQ73	C	
Y1	PL59A	6		T (LVDS)*	PL71A	6	LDQ73	T (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
Y2	PL59B	6		C (LVDS)*	PL71B	6	LDQ73	C (LVDS)*	
Y5	PL60A	6		T	PL72A	6	LDQ73	T	
Y6	PL60B	6		C	PL72B	6	LDQ73	C	
AA1	NC	-			PL73A	6	LDQS73	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
AA2	NC	-			PL73B	6	LDQ73	C (LVDS)*	
Y3	NC	-			PL74A	6	LDQ73	T	
AB1	NC	-			PL74B	6	LDQ73	C	
-	-	-			VCCIO6	6			
Y9	NC	-			PL75A	6	LDQ73	T (LVDS)*	
Y8	NC	-			PL75B	6	LDQ73	C (LVDS)*	
Y7	NC	-			PL76A	6	LDQ73	T	
AA7	NC	-			PL76B	6	LDQ73	C	
-	-	-			GNDIO6	-			
-	-	-			-	-			
AB2	NC	-			PL78A	6	LDQ82	T (LVDS)*	
AB3	NC	-			PL78B	6	LDQ82	C (LVDS)*	
AA5	NC	-			PL79A	6	LDQ82	T	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
E13	PT28A	0		T	PT37A	0		T	
VCCIO	VCCIO0	0			VCCIO0	0			
GNDIO	GNDIO0	-			GNDIO0	-			
J12	PT5B	0		C	PT31B	0		C	
GNDIO	GNDIO0	-			-	-			
VCCIO	VCCIO0	0			VCCIO0	0			
H10	PT5A	0		T	PT31A	0		T	
E12	PT4B	0		C	PT30B	0		C	
D11	PT4A	0		T	PT30A	0		T	
H11	PT3B	0		C	PT29B	0		C	
F11	PT3A	0		T	PT29A	0		T	
C13	VCC	-			ULC_SQ_VCCR0	11			
A12	PT19A	0		T	ULC_SQ_HDINP0	11		T	
B13	NC	-			ULC_SQ_VCCIB0	11			
B12	PT19B	0		C	ULC_SQ_HDINN0	11		C	
C10	VCC	-			ULC_SQ_VCCTX0	11			
A9	PT17A	0		T	ULC_SQ_HDOUTP0	11		T	
A10	NC	-			ULC_SQ_VCCOB0	11			
B9	PT17B	0		C	ULC_SQ_HDOUTN0	11		C	
C9	VCC	-			ULC_SQ_VCCTX1	11			
B8	PT18B	0		C	ULC_SQ_HDOUTN1	11		C	
C8	NC	-			ULC_SQ_VCCOB1	11			
A8	PT18A	0		T	ULC_SQ_HDOUTP1	11		T	
C12	VCC	-			ULC_SQ_VCCR1	11			
B11	PT16B	0		C	ULC_SQ_HDINN1	11		C	
C11	NC	-			ULC_SQ_VCCIB1	11			
A11	PT16A	0		T	ULC_SQ_HDINP1	11		T	
B7	VCCAUX	-			ULC_SQ_VCCAUX33	11			
E7	PT15B	0		C	ULC_SQ_REFCLKN	11		C	
D7	PT15A	0		T	ULC_SQ_REFCLKP	11		T	
C7	VCC	-			ULC_SQ_VCCP	11			
A3	PT12A	0		T	ULC_SQ_HDINP2	11		T	
C3	NC	-			ULC_SQ_VCCIB2	11			
B3	PT12B	0		C	ULC_SQ_HDINN2	11		C	
C2	VCC	-			ULC_SQ_VCCR2	11			
A6	PT14A	0		T	ULC_SQ_HDOUTP2	11		T	
C6	NC	-			ULC_SQ_VCCOB2	11			
B6	PT14B	0		C	ULC_SQ_HDOUTN2	11		C	
C5	VCC	-			ULC_SQ_VCCTX2	11			
B5	PT13B	0		C	ULC_SQ_HDOUTN3	11		C	
A4	NC	-			ULC_SQ_VCCOB3	11			
A5	PT13A	0		T	ULC_SQ_HDOUTP3	11		T	
C4	VCC	-			ULC_SQ_VCCTX3	11			
B2	PT11B	0		C	ULC_SQ_HDINN3	11		C	
B1	NC	-			ULC_SQ_VCCIB3	11			
A2	PT11A	0		T	ULC_SQ_HDINP3	11		T	
C1	VCC	-			ULC_SQ_VCCR3	11			
L12	VCC	-			VCC	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
AA1	PL81A	6	LDQS81	T (LVDS)*
GNDIO	GNDIO6	-		
AA2	PL81B	6	LDQ81	C (LVDS)*
Y3	PL82A	6	LDQ81	T
AB1	PL82B	6	LDQ81	C
VCCIO	VCCIO6	6		
Y9	PL83A	6	LDQ81	T (LVDS)*
Y8	PL83B	6	LDQ81	C (LVDS)*
Y7	PL84A	6	LDQ81	T
AA7	PL84B	6	LDQ81	C
GNDIO	GNDIO6	-		
VCCIO	VCCIO6	6		
AB2	PL95A	6	LDQ99	T (LVDS)*
AB3	PL95B	6	LDQ99	C (LVDS)*
AA5	PL96A	6	LDQ99	T
AA6	PL96B	6	LDQ99	C
AB4	PL97A	6	LDQ99	T (LVDS)*
VCCIO	VCCIO6	6		
AB5	PL97B	6	LDQ99	C (LVDS)*
AA8	PL98A	6	LDQ99	T
AA9	PL98B	6	LDQ99	C
AC1	PL99A	6	LLM0_GPLLT_IN_A**/LDQS99	T (LVDS)*
GNDIO	GNDIO6	-		
AC2	PL99B	6	LLM0_GPLLC_IN_A**/LDQ99	C (LVDS)*
AC4	PL100A	6	LLM0_GPLLT_FB_A/LDQ99	T
AC3	PL100B	6	LLM0_GPLLC_FB_A/LDQ99	C
VCCIO	VCCIO6	6		
AC7	PL101A	6	LLM0_GDLLT_IN_A**/LDQ99	T (LVDS)*
AC6	PL101B	6	LLM0_GDLLC_IN_A**/LDQ99	C (LVDS)*
AC5	PL102A	6	LLM0_GDLLT_FB_A/LDQ99	T
AD3	PL102B	6	LLM0_GDLLC_FB_A/LDQ99	C
GNDIO	GNDIO6	-		
AB8	LLM0_PLLCAP	6		
AD2	PL104A	6		T
AD1	PL104B	6		C
AE2	TCK	-		
AE1	TDI	-		
AF2	TMS	-		
AF1	TDO	-		
AG1	VCCJ	-		
AH1	LLC_SQ_VCCR3	14		
AK2	LLC_SQ_HDINP3	14		T
AJ1	LLC_SQ_VCCIB3	14		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO5	-			GNDIO5	-		
AE16	PB42B	5	BDQ42	C	PB51B	5	BDQ51	C
AF15	PB44A	5	BDQ42	T	PB53A	5	BDQ51	T
VCCIO	VCCIO5	5			VCCIO5	5		
AD16	PB44B	5	BDQ42	C	PB53B	5	BDQ51	C
AK17	PB45A	5	BDQ42	T	PB54A	5	BDQ51	T
AH16	PB45B	5	BDQ42	C	PB54B	5	BDQ51	C
AN16	PB46A	5	BDQ42	T	PB55A	5	BDQ51	T
GNDIO	GNDIO5	-			GNDIO5	-		
AP16	PB46B	5	BDQ42	C	PB55B	5	BDQ51	C
AL17	PB47A	5	BDQ51	T	PB56A	5	BDQ60	T
AM17	PB47B	5	BDQ51	C	PB56B	5	BDQ60	C
AN17	PB48A	5	BDQ51	T	PB57A	5	BDQ60	T
AP17	PB48B	5	BDQ51	C	PB57B	5	BDQ60	C
AD17	PB49A	5	BDQ51	T	PB58A	5	BDQ60	T
AE17	PB49B	5	BDQ51	C	PB58B	5	BDQ60	C
VCCIO	VCCIO5	5			VCCIO5	5		
AL18	PB50A	5	BDQ51	T	PB59A	5	BDQ60	T
AM18	PB50B	5	BDQ51	C	PB59B	5	BDQ60	C
GNDIO	GNDIO5	-			GNDIO5	-		
AP18	PB51A	5	BDQS51	T	PB60A	5	BDQS60	T
AN18	PB51B	5	BDQ51	C	PB60B	5	BDQ60	C
AG17	PB52A	5	VREF2_5/BDQ51	T	PB61A	5	VREF2_5/BDQ60	T
AJ17	PB52B	5	VREF1_5/BDQ51	C	PB61B	5	VREF1_5/BDQ60	C
AF17	PB53A	5	PCLKT5_0/BDQ51	T	PB62A	5	PCLKT5_0/BDQ60	T
AH17	PB53B	5	PCLKC5_0/BDQ51	C	PB62B	5	PCLKC5_0/BDQ60	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
AF18	PB58A	4	PCLKT4_0/BDQ60	T	PB67A	4	PCLKT4_0/BDQ69	T
VCCIO	VCCIO4	4			VCCIO4	4		
AD18	PB58B	4	PCLKC4_0/BDQ60	C	PB67B	4	PCLKC4_0/BDQ69	C
AP19	PB59A	4	VREF2_4/BDQ60	T	PB68A	4	VREF2_4/BDQ69	T
AN19	PB59B	4	VREF1_4/BDQ60	C	PB68B	4	VREF1_4/BDQ69	C
AP20	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T
GNDIO	GNDIO4	-			GNDIO4	-		
AM20	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C
AN20	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T
AM21	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C
AG18	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T
VCCIO	VCCIO4	4			VCCIO4	4		
AE18	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C
AJ18	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T
AH18	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C
AK18	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T
GNDIO	GNDIO4	-			GNDIO4	-		
AK19	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C
AP21	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T
AN21	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C
AL20	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
U22	GND	-			GND	-		
U23	GND	-			GND	-		
V12	GND	-			GND	-		
V13	GND	-			GND	-		
V15	GND	-			GND	-		
V16	GND	-			GND	-		
V17	GND	-			GND	-		
V18	GND	-			GND	-		
V19	GND	-			GND	-		
V20	GND	-			GND	-		
V22	GND	-			GND	-		
V23	GND	-			GND	-		
W12	GND	-			GND	-		
W13	GND	-			GND	-		
W15	GND	-			GND	-		
W16	GND	-			GND	-		
W17	GND	-			GND	-		
W18	GND	-			GND	-		
W19	GND	-			GND	-		
W20	GND	-			GND	-		
W22	GND	-			GND	-		
W23	GND	-			GND	-		
W26	GND	-			GND	-		
W31	GND	-			GND	-		
W4	GND	-			GND	-		
W9	GND	-			GND	-		
Y16	GND	-			GND	-		
Y17	GND	-			GND	-		
Y18	GND	-			GND	-		
Y19	GND	-			GND	-		
A11	NC	-			NC	-		
A12	NC	-			NC	-		
A23	NC	-			NC	-		
A24	NC	-			NC	-		
AA11	NC	-			NC	-		
AB11	NC	-			NC	-		
AC26	NC	-			NC	-		
AC30	NC	-			NC	-		
AD11	NC	-			NC	-		
AD12	NC	-			NC	-		
AD13	NC	-			NC	-		
AD14	NC	-			NC	-		
AD15	NC	-			NC	-		
AD19	NC	-			NC	-		
AD21	NC	-			NC	-		
AD22	NC	-			NC	-		
AD23	NC	-			NC	-		
AE10	NC	-			NC	-		
AE11	NC	-			NC	-		

LatticeECP2 Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144C	90	1.2V	-5	TQFP	144	COM	6
LFE2-6E-6T144C	90	1.2V	-6	TQFP	144	COM	6
LFE2-6E-7T144C	90	1.2V	-7	TQFP	144	COM	6
LFE2-6E-5F256C	190	1.2V	-5	fpBGA	256	COM	6
LFE2-6E-6F256C	190	1.2V	-6	fpBGA	256	COM	6
LFE2-6E-7F256C	190	1.2V	-7	fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144C	93	1.2V	-5	TQFP	144	COM	12
LFE2-12E-6T144C	93	1.2V	-6	TQFP	144	COM	12
LFE2-12E-7T144C	93	1.2V	-7	TQFP	144	COM	12
LFE2-12E-5Q208C	131	1.2V	-5	PQFP	208	COM	12
LFE2-12E-6Q208C	131	1.2V	-6	PQFP	208	COM	12
LFE2-12E-7Q208C	131	1.2V	-7	PQFP	208	COM	12
LFE2-12E-5F256C	193	1.2V	-5	fpBGA	256	COM	12
LFE2-12E-6F256C	193	1.2V	-6	fpBGA	256	COM	12
LFE2-12E-7F256C	193	1.2V	-7	fpBGA	256	COM	12
LFE2-12E-5F484C	297	1.2V	-5	fpBGA	484	COM	12
LFE2-12E-6F484C	297	1.2V	-6	fpBGA	484	COM	12
LFE2-12E-7F484C	297	1.2V	-7	fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208C	131	1.2V	-5	PQFP	208	COM	20
LFE2-20E-6Q208C	131	1.2V	-6	PQFP	208	COM	20
LFE2-20E-7Q208C	131	1.2V	-7	PQFP	208	COM	20
LFE2-20E-5F256C	193	1.2V	-5	fpBGA	256	COM	20
LFE2-20E-6F256C	193	1.2V	-6	fpBGA	256	COM	20
LFE2-20E-7F256C	193	1.2V	-7	fpBGA	256	COM	20
LFE2-20E-5F484C	331	1.2V	-5	fpBGA	484	COM	20
LFE2-20E-6F484C	331	1.2V	-6	fpBGA	484	COM	20
LFE2-20E-7F484C	331	1.2V	-7	fpBGA	484	COM	20
LFE2-20E-5F672C	402	1.2V	-5	fpBGA	672	COM	20
LFE2-20E-6F672C	402	1.2V	-6	fpBGA	672	COM	20
LFE2-20E-7F672C	402	1.2V	-7	fpBGA	672	COM	20

Date	Version	Section	Change Summary
August 2006 (cont.)	01.1 (cont.)	Pinout Information (cont.)	Added Information on: Available Device Resources per Packaged Device table.
		Ordering Information	Updated ordering part number table to include ECP2-12.
			Updated topside mark drawing.
September 2006	02.0	Multiple	Added information regarding LatticeECP2M support throughout.
September 2006	02.1	DC and Switching Characteristics	Added Receiver Total Jitter Tolerance Specification table.
			Removed power-up requirements for proper configuration footnote in Recommended Operating Conditions table.
December 2006	02.2	Introduction	LatticeECP2M Selection Guide table has been updated.
		Architecture	Figure 2-16. Per Region Secondary Clock Selection has been updated.
			Figure 2-39. Simplified Channel Block Diagram for SERDES and PCS has been updated.
		DC and Switching	Footnotes have been added to Recommended Operating Conditions.
			DC Electrical Characteristics table has been updated.
			Supply Current (Standby) tables have been updated.
			Initialization Supply Current table have been updated.
			Updated timing numbers to include LFE2-12E (rev A 0.08).
		Pinout Information	Updated to include the entire ECP2 device information as well as 256-fpBGA and 484-fpBGA pin information for the ECP2M35E.
		Ordering Information	Updated to include the entire ECP2 and ECP2M device ordering information.
February 2007	02.3	Architecture	Updated EBR Asynchronous Reset section.
March 2007	02.4	DC and Switching Characteristics	Power-sequencing footnotes have been added to the Recommended Operating Conditions. DDR2 performance has been updated to 266MHz.
March 2007	02.5	Introduction	Added "Security Series" to the LatticeECP2 and LatticeECP2M families.
		Architecture	Enhanced Configuration Option section updated.
		DC and Switching	Recommended Operating Conditions table - footnote 4 updated.
		Ordering Information	"Security Series" ordering part numbers added.
April 2007	02.6	Introduction	LatticeECP2M family table has been updated for user I/O counts.
		Ordering Information	LatticeECP2M family ordering part number section has been updated to add 1152-fpBGA package for the ECP2M70 and ECP2M100.
July 2007	02.7	Architecture	Updated text in Ripple Mode section.
		DC and Switching	ECP2/M Supply Current information has been updated. Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.10). SERDES timing information has been updated. PCI Express timing information has been updated.
		Pinout Information	Added LatticeECP2M20 pinout information.
August 2007	02.8	Introduction	1156-fpBGA package option has been removed from the LatticeECP2M family.
		Architecture	Table 2-16. Selectable Master Clock (CCLK) Frequencies During Configuration table has been updated.
		DC and Switching	Supply Current (Standby) table has been updated.
			DSP Function timing has been updated.